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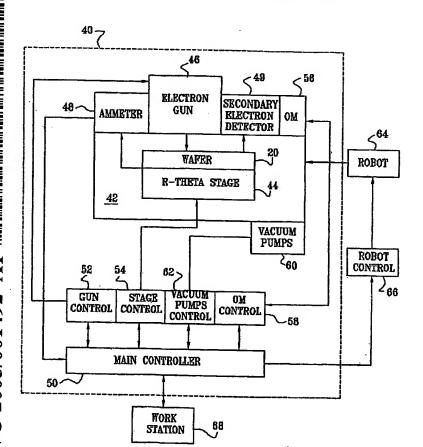
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- (71) Applicant (for all designated States except US, ZW): AP-PLIED MATERIALS ISRAEL, LTD. [IL/IL]; 8 Oppenheimer Street, 76236 Rehovot (IL).
- (71) Applicant (for ZW only): APPLIED MATERIALS, INC. [US/US]; P.O. Box 450A, Santa CLara, CA 95052 (US).

- (72) Inventors; and
- (75) Inventors/Applicants (for US only): KADYSHE-VITCH, Alexander [IL/IL]; 20/5 Eliyahu Hanavi St., 71700 Modiin (IL). SHUR, Dmitry [—/IL]; Holon (IL). TALBOT, Christopher [GB/US]; 6 Summit Court, Emerals Hills, CA 94062 (US).
- (74) Agent: FAHMI, Tarek; 12400 Wilshire Boulevard, 7th Floor, Los Angeles, CA 90025 (US).
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[Continued on next page]

### (54) Title: HIGH CURRENT ELECTRON BEAM INSPECTION



(57) Abstract: A method and apparatus for wafer inspection. The apparatus is capable of testing a sample having a first layer that is at least partly conductive and a second, dielectric layer formed over the first layer, following production of contact openings in the second layer, the apparatus includes: (i) an electron beam source adapted to direct a high current beam of charged particles to simultaneously irradiate a large number of contact openings at multiple locations distributed over an area of the sample; (ii) a current measuring device adapted to measure a specimen current flowing through the first layer in response to irradiation of the large number of contact openings at the multiple locations; and (iii) a controller adapted to provide an indication of the at least defective hole in response to the measurement.

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